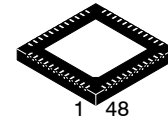


# 3.3 V 100/133 MHz Differential 1:8 HCSL- Compatible Push-Pull Clock ZDB/Fanout Buffer for PCIe®



CASE 485DP

## NB3W800L

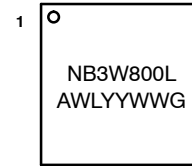
### Description

The NB3W800L is a low-power 8-output differential buffer that meets all the performance requirements of the DB800ZL specification. The NB3W800L is capable of distributing the reference clocks for Intel® QuickPath Interconnect (Intel QPI and UPI), PCIe Gen1/Gen2/Gen3/Gen4, SAS, SATA, and Intel Scalable Memory Interconnect (Intel SMI) applications. A fixed, internal feedback path maintains low drift for critical QPI applications.

### Features

- 8 Differential Clock Output Pairs @ 0.7 V
- Low-power NMOS Push-pull HCSL Compatible Outputs
- Cycle-to-cycle Jitter <50 ps
- Output-to-output Skew <50 ps
- Input-to-output Delay Variation <100 ps
- PCIe Phase Jitter: Gen3 <1.0 ps, Gen4 <0.5 ps RMS
- QPI 9.6GT/s 12UI Phase Jitter <0.2 ps RMS
- Pseudo-External Fixed Feedback for Lowest Input-to-Output Delay
- Individual OE Control; Hardware Control of Each Output
- PLL Configurable for PLL Mode or Bypass Mode (Fanout Operation)
- 100 MHz or 133 MHz PLL Mode Operation; Supports PCIe, QPI and UPI Applications
- Selectable PLL Bandwidth; Minimizes Jitter Peaking in Downstream PLL's
- SMBus Programmable Configurations
- Spread Spectrum Compatible; Tracks Input Clock Spreading for Low EMI
- These are Pb-Free Devices

### MARKING DIAGRAM



NB3W800L = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

### ORDERING INFORMATION

| Device        | Package            | Shipping*             |
|---------------|--------------------|-----------------------|
| NB3W800LMNG   | QFN48<br>(Pb-Free) | 490 / Tray            |
| NB3W800LMNTXG | QFN48<br>(Pb-Free) | 2500 / Tape &<br>Reel |

\*Pin 1 in upper left corner of Tape and Reel

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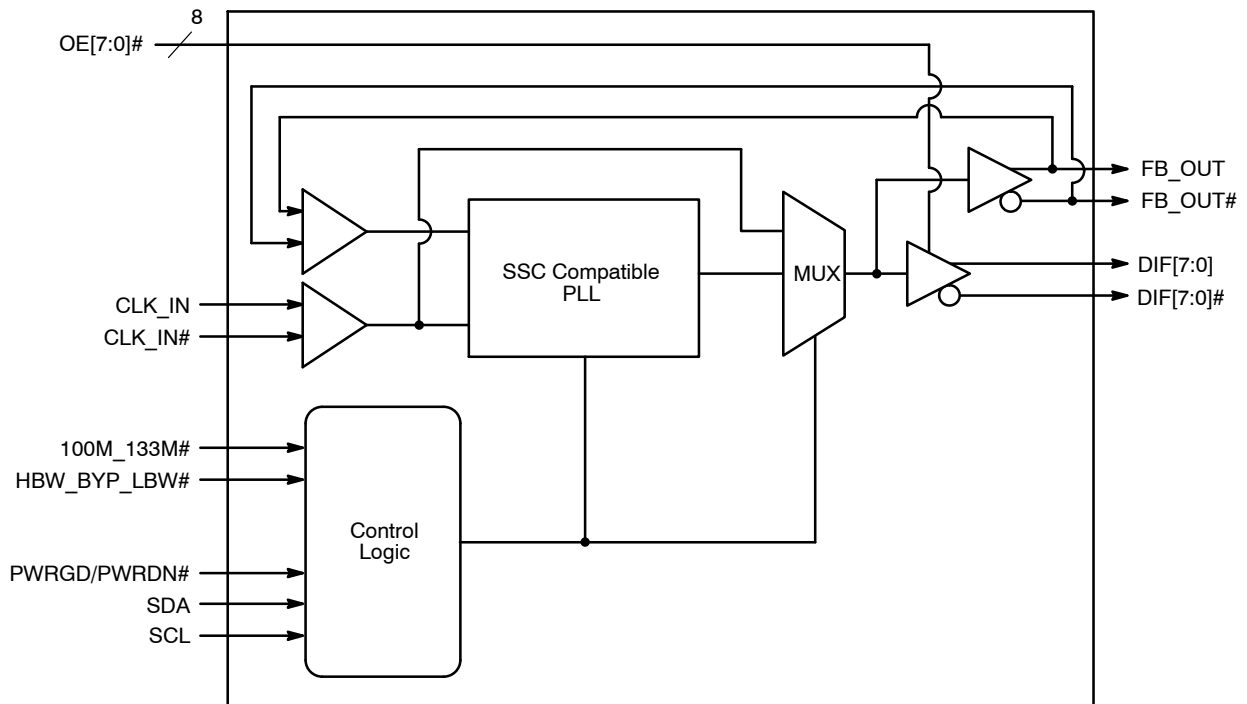


Figure 1. Simplified Block Diagram

Table 1. OE AND POWER PIN TABLE

| Inputs           |                    | OE# Hardware Pins & Control Register Bits |         |                | Outputs            | PLL State |
|------------------|--------------------|---|---------|----------------|--------------------|-----------|
| PWRGD/<br>PWRDN# | CLK_IN/<br>CLK_IN# | SMBUS<br>Enable Bit                       | OE# Pin | DIF/DIF# [7:0] | FB_OUT/<br>FB_OUT# |           |
| 0                | X                  | X   | X       | Hi-Z           | Hi-Z               | OFF       |
| 1                | Running            | 0   | X       | Hi-Z           | Running            | ON        |
|                  |                    | 1   | 0       | Running        | Running            | ON        |
|                  |                    | 1   | 1       | Hi-Z           | Running            | ON        |

Table 2. FUNCTIONALITY AT POWER-UP (PLL MODE)

| 100M_133M# | CLK_IN MHz | DIF(7:0) |
|------------|------------|----------|
| 1          | 100.00     | CLK_IN   |
| 0          | 133.33     | CLK_IN   |

Table 3. POWER CONNECTIONS

| Pin Number                 |     | Description  |
|----------------------------|-----|--------------|
| VDD                        | GND |              |
| 44                         | 49  | Analog PLL   |
| 3                          | 2   | Analog Input |
| 10, 15, 19, 27, 34, 38, 42 | 49  | DIF clocks   |

Table 4. SMBus ADDRESS

| Address | + Read/Write bit |
|---------|------------------|
| D8      | R                |

Table 5. PLL OPERATING MODE READBACK TABLE

| HBW_BYP_LBW#   | Byte0, bit 7 | Byte 0, bit 6 |
|----------------|--------------|---------------|
| Low (Low BW)   | 0            | 0             |
| Mid (Bypass)   | 0            | 1             |
| High (High BW) | 1            | 1             |

Table 6. TRI-LEVEL INPUT THRESHOLDS

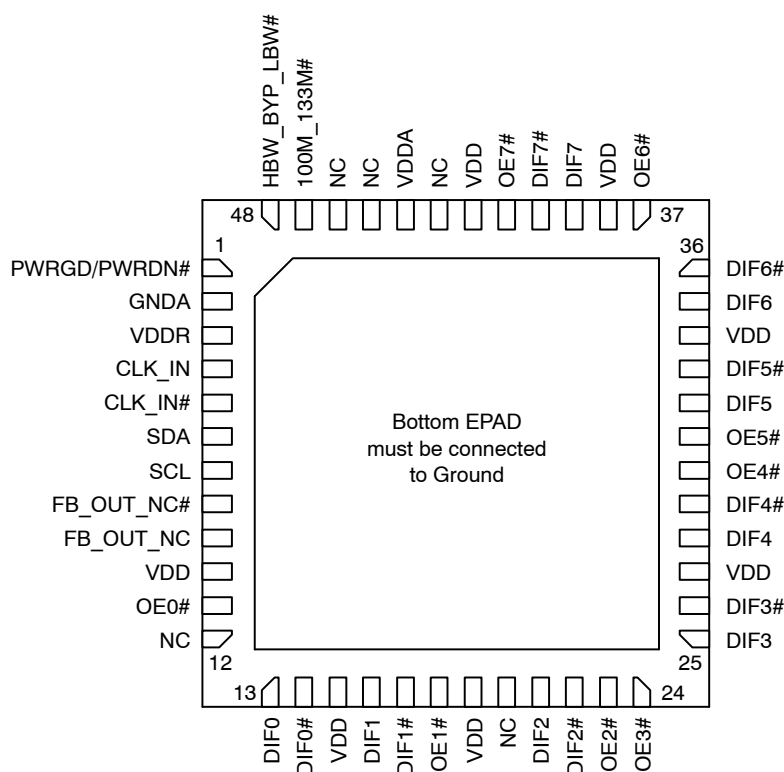
| Level | Voltage           |
|-------|-------------------|
| Low   | <0.8 V            |
| Mid   | 1.2 < Vin < 1.8 V |
| High  | Vin > 2.2 V       |

Table 7. PLL OPERATING MODE

| HBW_BYP_LBW# | Mode      |
|--------------|-----------|
| Low          | PLL Lo BW |
| Mid          | Bypass    |
| High         | PLL Hi BW |

NOTE: PLL is OFF in Bypass Mode

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**Figure 2. Pin Configuration**

**Table 8. PIN DESCRIPTIONS**

| Pin # | Pin Name     | Type | Description   |
|-------|--------------|------|---|
| 1     | PWRGD/PWRDN# | IN   | 3.3 V Input notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on subsequent assertions. Low enters Power Down Mode.  |
| 2     | GNDA         | GND  | Ground for Input Receiver and PLL Core  |
| 3     | VDDR         | PWR  | 3.3 V power for differential input clock (receiver). This VDD should be treated as an analog power rail and filtered appropriately.   |
| 4     | CLK_IN       | IN   | 0.7 V Differential true input   |
| 5     | CLK_IN#      | IN   | 0.7 V Differential complementary Input  |
| 6     | SDA          | I/O  | Data pin of SMBus circuitry   |
| 7     | SCL          | IN   | Clock pin of SMBus circuitry  |
| 8     | FB_OUT_NC#   | OUT  | Complementary half of differential feedback output provides feedback signal to the PLL for synchronization with input clock to eliminate phase error. This pin should NOT be connected on the circuit board; the feedback is internal to the package. |
| 9     | FB_OUT_NC    | OUT  | True half of differential feedback output provides feedback signal to the PLL for synchronization with the input clock to eliminate phase error. This pin should NOT be connected on the circuit board; the feedback is internal to the package.      |
| 10    | VDD          | PWR  | Power supply, nominal 3.3 V   |
| 11    | OE0#         | IN   | Active low input for enabling DIF pair 0. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs  |
| 12    | NC           | N/A  | No Connection.  |
| 13    | DIF0         | OUT  | 0.7 V differential true clock output  |
| 14    | DIF0#        | OUT  | 0.7 V differential complementary clock output   |
| 15    | VDD          | PWR  | Power supply, nominal 3.3 V   |
| 16    | DIF1         | OUT  | 0.7 V differential true clock output  |

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**Table 8. PIN DESCRIPTIONS**

| Pin # | Pin Name     | Type | Description  |
|-------|--------------|------|--|
| 17    | DIF1#        | OUT  | 0.7 V differential complementary clock output  |
| 18    | OE1#         | IN   | Active low input for enabling DIF pair 1. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 19    | VDD          | PWR  | Power supply, nominal 3.3 V  |
| 20    | NC           | N/A  | No Connection.   |
| 21    | DIF2         | OUT  | 0.7 V differential true clock output   |
| 22    | DIF2#        | OUT  | 0.7 V differential complementary clock output  |
| 23    | OE2#         | IN   | Active low input for enabling DIF pair 2. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 24    | OE3#         | IN   | Active low input for enabling DIF pair 3. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 25    | DIF3         | OUT  | 0.7 V differential true clock output   |
| 26    | DIF3#        | OUT  | 0.7 V differential complementary clock output  |
| 27    | VDD          | PWR  | Power supply, nominal 3.3 V  |
| 28    | DIF4         | OUT  | 0.7 V differential true clock output   |
| 29    | DIF4#        | OUT  | 0.7 V differential complementary clock output  |
| 30    | OE4#         | IN   | Active low input for enabling DIF pair 4. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 31    | OE5#         | IN   | Active low input for enabling DIF pair 5. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 32    | DIF5         | OUT  | 0.7 V differential true clock output   |
| 33    | DIF5#        | OUT  | 0.7 V differential complementary clock output  |
| 34    | VDD          | PWR  | Power supply, nominal 3.3 V  |
| 35    | DIF6         | OUT  | 0.7 V differential true clock output   |
| 36    | DIF6#        | OUT  | 0.7 V differential complementary clock output  |
| 37    | OE6#         | IN   | Active low input for enabling DIF pair 6. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 38    | VDD          | PWR  | Power supply, nominal 3.3 V  |
| 39    | DIF7         | OUT  | 0.7 V differential true clock output   |
| 40    | DIF7#        | OUT  | 0.7 V differential complementary clock output  |
| 41    | OE7#         | IN   | Active low input for enabling DIF pair 7. This pin has an internal pull-down.<br>1 = disable outputs, 0 = enable outputs |
| 42    | VDD          | PWR  | Power supply, nominal 3.3 V  |
| 43    | NC           | N/A  | No Connection.   |
| 44    | VDDA         | PWR  | 3.3 V power for the PLL core.  |
| 45    | NC           | N/A  | No Connection.   |
| 46    | NC           | N/A  | No Connection.   |
| 47    | 100M_133M#   | IN   | 3.3 V Input to select operating frequency. See Functionality Table for Definition  |
| 48    | HBW_BYP_LBW# | IN   | Trilevel input to select High BW, Bypass or Low BW mode.<br>See PLL Operating Mode Table for Details.                    |
| 49    | GND          | PWR  | EPAD, must be connected to Ground  |

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**Table 9. ABSOLUTE MAXIMUM RATINGS**

| Symbol             | Parameter                               | Conditions                 | Min     | Typ | Max                   | Units |
|--------------------|---|----------------------------|---------|-----|-----------------------|-------|
| VDD, VDDA          | 3.3 V Supply Voltage (Notes 1, 2)       | VDD for core logic and PLL |         |     | 4.6                   | V     |
| V <sub>IL</sub>    | Input Low Voltage (Note 1)              |                            | GND-0.5 |     |                       | V     |
| V <sub>IH</sub>    | Input High Voltage (Note 1)             | Except for SMBus interface |         |     | V <sub>DD</sub> + 0.5 | V     |
| V <sub>IHSMB</sub> | Input High Voltage (Note 1)             | SMBus clock and data pins  |         |     | 5.5                   | V     |
| T <sub>s</sub>     | Storage Temperature (Note 1)            |                            | -65     |     | 150                   | °C    |
| T <sub>j</sub>     | Junction Temperature (Note 1)           |                            |         |     | 125                   | °C    |
| ESD prot           | Input ESD protection (Note 1)           | Human Body Model           | 2000    |     |                       | V     |
| θ <sub>JA</sub>    | Thermal Resistance, Junction-to-Ambient | Still air                  |         | 17  |                       | °C/W  |
| θ <sub>JC</sub>    | Thermal Resistance, Junction-to-Case    |                            |         | 7   |                       | °C/W  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Guaranteed by design and characterization, not tested in production.
2. Operation under these conditions is neither implied nor guaranteed.

**Table 10. ELECTRICAL CHARACTERISTICS—CLOCK INPUT PARAMETERS (HCSL-COMPATIBLE)**

(V<sub>DD</sub> = V<sub>DDA</sub> = 3.3 V ±5%, T<sub>A</sub> = 0°C – 70°C), See Test Loads for Loading Conditions. (Note 5)

| Symbol                | Parameter                                   | Conditions  | Min                   | Typ | Max  | Units |
|-----------------------|---|---|-----------------------|-----|------|-------|
| V <sub>IHCLK_IN</sub> | Input High Voltage - CLK_IN (Note 3)        | Differential inputs (single-ended measurement)            | 600                   | 800 | 1150 | mV    |
| V <sub>ILCLK_IN</sub> | Input Low Voltage - CLK_IN (Note 3)         | Differential inputs (single-ended measurement)            | V <sub>SS</sub> - 300 | 0   | 300  | mV    |
| V <sub>COM</sub>      | Input Common Mode Voltage - CLK_IN (Note 3) | Common Mode Input Voltage (Single-ended measurement)      | 300                   |     | 1000 | mV    |
| V <sub>SWING</sub>    | Input Amplitude - CLK_IN (Note 3)           | Peak to Peak (differential)                               | 300                   |     | 1450 | mV    |
| dv/dt                 | Input Slew Rate - CLK_IN (Notes 3, 4)       | Measured differentially                                   | 0.35                  |     | 8    | V/ns  |
| I <sub>IN</sub>       | Input Leakage Current (Note 3)              | V <sub>IN</sub> = V <sub>DD</sub> , V <sub>IN</sub> = GND | -5                    |     | 5    | μA    |
| d <sub>tin</sub>      | Input Duty Cycle (Note 3)                   | Measurement from differential waveform                    | 45                    |     | 55   | %     |
| J <sub>DIFIn</sub>    | Input Jitter - Cycle to Cycle (Note 3)      | Differential Measurement                                  |                       |     | 125  | ps    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Guaranteed by design and characterization, not tested in production.
4. Slew rate measured through ±75 mV window centered around differential zero.
5. Test configuration is; R<sub>s</sub> = 27 Ω, 2 pF for 85 Ω transmission line.

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**Table 11. ELECTRICAL CHARACTERISTICS – Input/Supply/Common Parameters**

( $V_{DD} = V_{DDA} = 3.3\text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C} - 70^\circ\text{C}$ ), See Test Loads for Loading Conditions. (Note 11)

| Symbol          | Parameter                               | Conditions  | Min                | Typ    | Max            | Units         |
|-----------------|---|---|--------------------|--------|----------------|---------------|
| $V_{IH}$        | Input High Voltage (Note 6)             | Single-ended inputs, except SMBus, low threshold and tri-level inputs   | 2                  |        | $V_{DD} + 0.3$ | V             |
| $V_{IL}$        | Input Low Voltage (Note 6)              | Single-ended inputs, except SMBus, low threshold and tri-level inputs   | $\text{GND} - 0.3$ |        | 0.8            | V             |
| $I_{IN}$        | Input Current (Note 6)                  | Single-ended inputs, $V_{IN} = \text{GND}$ , $V_{IN} = V_{DD}$  | -5                 |        | 5              | $\mu\text{A}$ |
| $I_{INP}$       |   | Single-ended inputs $V_{IN} = 0\text{ V}$ ; Inputs with internal pull-up resistors $V_{IN} = V_{DD}$ ; Inputs with internal pull-down resistors | -200               |        | 200            | $\mu\text{A}$ |
| $F_{ibyp}$      | Input Frequency (Note 7)                | $V_{DD} = 3.3\text{ V}$ , Bypass mode   | 33                 |        | 150            | MHz           |
| $F_{ipll}$      |   | $V_{DD} = 3.3\text{ V}$ , 100 MHz PLL mode  | 99                 | 100.00 | 101            | MHz           |
| $F_{ipll}$      |   | $V_{DD} = 3.3\text{ V}$ , 133.33 MHz PLL mode   | 132.33             | 133.33 | 134.33         | MHz           |
| $L_{pin}$       | Pin Inductance (Note 6)                 |   |                    |        | 7              | nH            |
| $C_{IN}$        | Capacitance (Note 6)                    | Logic Inputs, except CLK_IN   | 1.5                |        | 4.5            | pF            |
| $C_{INCLK\_IN}$ |   | CLK_IN differential clock inputs (Note 9)   | 1.5                |        | 2.7            | pF            |
| $C_{OUT}$       |   | Output pin capacitance  |                    |        | 4.5            | pF            |
| $f_{MODIN}$     | Input SS Modulation Frequency (Note 6)  | Allowable Frequency (Triangular Modulation)   | 30                 |        | 33             | kHz           |
| $t_{LATO\#}$    | OE# Latency (Notes 6, 8)                | DIF start after OE# assertion<br>DIF stop after OE# deassertion   | 4                  |        | 8              | cycles        |
| $t_{DRVPD}$     | Tdrive_PD# (Notes 6, 8)                 | DIF output enable after PD# de-assertion  |                    |        | 300            | $\mu\text{s}$ |
| $t_F$           | Tfall (Notes 6, 7)                      | Fall time of control inputs   |                    |        | 10             | ns            |
| $t_R$           | Trise (Notes 6, 7)                      | Rise time of control inputs   |                    |        | 10             | ns            |
| $V_{ILSMB}$     | SMBus Input Low Voltage (Note 6)        |   |                    |        | 0.8            | V             |
| $V_{IHSMB}$     | SMBus Input High Voltage (Note 6)       |   | 2.1                |        | $V_{DDSMB}$    | V             |
| $V_{OLSMB}$     | SMBus Output Low Voltage (Note 6)       | @ $I_{PULLUP}$  |                    |        | 0.4            | V             |
| $I_{PULLUP}$    | SMBus Sink Current (Note 6)             | @ $V_{OL}$  | 4                  |        |                | mA            |
| $V_{DDSMB}$     | Nominal Bus Voltage (Note 6)            | 3 V to 5 V $\pm 10\%$   | 2.7                |        | 5.0            | V             |
| $t_{RSMB}$      | SCL/SDA Rise Time (Note 6)              | (Max $V_{IL} - 0.15$ ) to (Min $V_{IH} + 0.15$ )  |                    |        | 1000           | ns            |
| $t_{FSMB}$      | SCL/SDA Fall Time (Note 6)              | (Min $V_{IH} + 0.15$ ) to (Max $V_{IL} - 0.15$ )  |                    |        | 300            | ns            |
| $f_{MAXSMB}$    | SMBus Operating Frequency (Notes 6, 10) | Maximum SMBus operating frequency   |                    |        | 100            | kHz           |

6. Guaranteed by design and characterization, not tested in production.

7. Control input must be monotonic from 20% to 80% of input swing.

8. Time from deassertion until outputs are  $>200\text{ mV}$

9. CLK\_IN input

10. The differential input clock must be running for the SMBus to be active

11. Test configuration is;  $R_s = 27\ \Omega$ ,  $2\text{ pF}$  for  $85\ \Omega$  transmission line.

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**Table 12. DIF 0.7 V AC TIMING CHARACTERISTICS (Non-Spread or –0.5% Spread Spectrum Mode)**

( $V_{DD} = V_{DDA} = 3.3 \text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C} - 70^\circ\text{C}$ ), See Test Loads for Loading Conditions.

| Symbol   | Parameter                                |              | CLK = 100 MHz, 133.33 MHz |                      | Unit |
|--|--|--------------|---------------------------|----------------------|------|
|  |  |              | Min                       | Max                  |      |
| Tstab (Note 32)  | Clock Stabilization Time                 |              |                           | 1.8                  | ms   |
| Laccuracy (Notes 15, 19, 27, 33)                             | Long Accuracy                            |              |                           | 100                  | ppm  |
| Tabs (Notes 15, 16, 19)                                      | Absolute Min/Max Host CLK Period         | No Spread    | 9.94900 for 100 MHz       | 10.05100 for 100 MHz | ns   |
|  |  |              | 7.44925 for 133 MHz       | 7.55075 for 133 MHz  |      |
|  |  | –0.5% Spread | 9.49900 for 100 MHz       | 10.10126 for 100 MHz |      |
|  |  |              | 7.44925 for 133 MHz       | 7.58845 for 133 MHz  |      |
| Slew_rate (Notes 13, 15, 19)                                 | DIFF OUT Slew_rate                       |              | 1.0                       | 4.0                  | V/ns |
| $\Delta\text{Trise} / \Delta\text{Tfall}$ (Notes 15, 19, 29) | Rise and Fall Time Variation             |              |                           | 125                  | ps   |
| Rise/Fall Matching (Notes 15, 19, 30, 31)                    |  |              |                           | 20                   | %    |
| VHigh (Notes 15, 18, 21)                                     | Voltage High (typ 0.70 Volts)            |              | 660                       | 850                  | mV   |
| VLow (Notes 15, 18, 22)                                      | Voltage Low (typ 0.0 Volts)              |              | –150                      | 150                  | mV   |
| Vmax (Note 18)   | Maximum Voltage                          |              |                           | 1150                 | mV   |
| Vcross absolute (Notes 12, 14, 15, 18, 25)                   | Absolute Crossing Point Voltages         |              | 250                       | 550                  | mV   |
| Vcross relative (Notes 15, 17, 18, 25)                       | Relative Crossing Point Voltages         |              | Calc                      | Calc                 |      |
| Total $\Delta$ Vcross (Notes 15, 18, 26)                     | Total Variation of Vcross Over All Edges |              |                           | 140                  | mV   |
| Vovs (Notes 15, 18, 23)                                      | Maximum Voltage (Overshoot)              |              |                           | Vhigh + 0.3          | V    |
| Vuds (Notes 15, 18, 24)                                      | Maximum Voltage (Undershoot)             |              |                           | Vlow – 0.3           | V    |

12. Measured at crossing point where the instantaneous voltage value of the rising edge of CLK equals the falling edge of CLK#.
13. Measurement taken from differential waveform on a component test board. The slew rate is measured from –150 mV to +150 mV on the differential waveform. Scope is set to average because the scope sample clock is making most of the dynamic wiggles along the clock edge. Only valid for Rising CLK\_IN and Falling CLK\_IN#. Signal must be monotonic through the Vol to Voh region for Trise and Tfall.
14. This measurement refers to the total variation from the lowest crossing point to the highest, regardless of which edge is crossing.
15. Test configuration is;  $R_s = 27 \Omega$ , 2 pF for 85  $\Omega$  transmission line.
16. The average period over any 1  $\mu\text{s}$  period of time must be greater than the minimum and less than the maximum specified period.
17. Vcross(rel) Min and Max are derived using the following, Vcross(rel) Min =  $0.250 + 0.5 (V_{\text{havg}} - 0.700)$ , Vcross(rel) Max =  $0.550 - 0.5 (0.700 - V_{\text{havg}})$
18. Measurement taken from Single Ended waveform.
19. Measurement taken from differential waveform. Bypass mode, input duty cycle = 50%.
20. Unless otherwise noted, all specifications in this table apply to all processor frequencies.
21. VHigh is defined as the statistical average High value as obtained by using the Oscilloscope VHigh Math function.
22. VLow is defined as the statistical average Low value as obtained by using the Oscilloscope VLow Math function.
23. Overshoot is defined as the absolute value of the maximum voltage.
24. Undershoot is defined as the absolute value of the minimum voltage.
25. The crossing point must meet the absolute and relative crossing point specifications simultaneously.
26.  $\Delta$ Vcross is defined as the total variation of all crossing voltages of Rising DIF and Falling DIF#. This is the maximum allowed variance in Vcross for any particular system.
27. Using frequency counter with the measurement interval equal or greater than 0.15 s, target frequencies are 100,000,000 Hz, 133,333,333 Hz.
28. Using frequency counter with the measurement interval equal or greater than 0.15 s, target frequencies are 99,750,00 Hz, 133,000,000 Hz.
29. Measured with oscilloscope, averaging off, using min max statistics. Variation is the delta between min and max.
30. Measured with oscilloscope, averaging on, The difference between the rising edge rate (average) of DIF versus the falling edge rate (average) of DIF#. Measured in a  $\pm 75$  mV window around the crosspoint of DIF and DIF#.
31. Rise/Fall matching is derived using the following,  $2 * (\text{Trise} - \text{Tfall}) / (\text{Trise} + \text{Tfall})$ .
32. This is the time from the valid CLK\_IN input clocks and the assertion of the PWRGD signal level at 1.8 V – 2.0 V to the time that stable clocks are output from the buffer chip (PLL locked).
33. All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK410B+/CK420BQ accuracy requirements. The NB3W800L itself does not contribute to ppm error.

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**Table 13. ELECTRICAL CHARACTERISTICS – Current Consumption**

( $V_{DD} = V_{DDA} = 3.3\text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C} - 70^\circ\text{C}$ ), See Test Loads for Loading Conditions. (Note 35)

| Symbol         | Parameter                   | Conditions                          | Min | Typ | Max | Units |
|----------------|-----------------------------|-------------------------------------|-----|-----|-----|-------|
| $I_{DDVDD}$    | Operating Current (Note 34) | 133 MHz, VDD rail                   |     | 94  | 105 | mA    |
| $I_{DDVDDA}$   |                             | 133 MHz, VDDA + VDDR rail, PLL Mode |     | 38  | 50  | mA    |
| $I_{DDVDDPD}$  | Powerdown Current (Note 34) | Power Down, VDD Rail                |     | 2.0 | 3.5 | mA    |
| $I_{DDVDDAPD}$ |                             | Power Down, VDDA Rail               |     | 0.5 | 1.0 | mA    |

34. Guaranteed by design and characterization, not tested in production.

35.  $C_L = 2\text{ pF}$  with  $R_S = 27\ \Omega$  for  $Z_o = 85\ \Omega$  differential trace impedance.

**Table 14. ELECTRICAL CHARACTERISTICS – Skew and Differential Jitter Parameters**

( $V_{DD} = V_{DDA} = 3.3\text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C} - 70^\circ\text{C}$ ), See Test Loads for Loading Conditions.

| Symbol          | Parameter                                      | Conditions  | Min  | Typ | Max | Units |
|-----------------|--|---|------|-----|-----|-------|
| $t_{SPO\_PLL}$  | CLK_IN, DIF[x:0]<br>(Notes 36, 37, 39, 40, 43) | Input-to-Output Skew in PLL mode<br>nominal value @ 25°C, 3.3 V                 | -100 |     | 100 | ps    |
| $t_{PD\_BYP}$   | CLK_IN, DIF[x:0]<br>(Notes 36, 37, 39, 40, 43) | Input-to-Output Skew in Bypass mode<br>nominal value @ 25°C, 3.3 V              | 2.5  |     | 4.5 | ns    |
| $t_{DSPO\_PLL}$ | CLK_IN, DIF[x:0]<br>(Notes 36, 37, 39, 40, 43) | Input-to-Output Skew Variation in PLL mode<br>across voltage and temperature    | -100 |     | 100 | ps    |
| $t_{DSPO\_BYP}$ | CLK_IN, DIF[x:0]<br>(Notes 36, 37, 39, 40, 43) | Input-to-Output Skew Variation in Bypass<br>mode across voltage and temperature | -250 |     | 250 | ps    |
| $t_{SKEW\_ALL}$ | DIF{x:0]<br>(Notes 36, 37, 39, 43)             | Output-to-Output Skew across all outputs<br>(Common to Bypass and PLL mode)     |      |     | 50  | ps    |
| $j_{peak-hbw}$  | PLL Jitter Peaking<br>(Notes 36, 42, 43)       | HBW_BYP_LBW# = 1  |      |     | 2.5 | dB    |
| $j_{peak-lbw}$  | PLL Jitter Peaking<br>(Notes 36, 42, 43)       | HBW_BYP_LBW# = 0  |      |     | 2   | dB    |
| $pll_{HBW}$     | PLL Bandwidth<br>(Notes 36, 43, 44)            | HBW_BYP_LBW# = 1  | 2    | 3   | 4   | MHz   |
| $pll_{LBW}$     | PLL Bandwidth<br>(Notes 36, 43, 44)            | HBW_BYP_LBW# = 0  | 0.7  | 1   | 1.4 | MHz   |
| $t_{DC}$        | Duty Cycle (Note 36, 46)                       | Measured differentially, PLL and Bypass Mode                                    | 45   | 50  | 55  | %     |
| $t_{DCD}$       | Duty Cycle Distortion<br>(Notes 36, 45)        | Measured differentially, Bypass Mode<br>@ 100 MHz                               | -2   | 0   | 2   | %     |
| $t_{jyc-cyc}$   | Jitter, Cycle to cycle<br>(Notes 36, 46)       | PLL mode  |      |     | 50  | ps    |
|                 |  | Additive Jitter in Bypass Mode  |      |     | 50  | ps    |

36.  $C_L = 2\text{ pF}$  with  $R_S = 27\ \Omega$  for  $Z_o = 85\ \Omega$  differential trace impedance. Input to output skew is measured at the first output edge following the corresponding input.

37. Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

38. All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

39. This parameter is deterministic for a given device

40. Measured with scope averaging on to find mean value.

41.  $t$  is the period of the input clock

42. Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

43. Guaranteed by design and characterization, not tested in production.

44. Measured at 3 db down or half power point.

45. Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

46. Measured from differential waveform. Bypass mode, input duty cycle = 50%.



# NB3W800L

**Table 15. ELECTRICAL CHARACTERISTICS – PHASE JITTER PARAMETERS**

(V<sub>DD</sub> = V<sub>D<sub>DA</sub></sub> = 3.3 V ±5%, TA = 0°C – 70°C), See Test Loads for Loading Conditions. (Note 35)

| Symbol                  | Parameter  | Conditions   | Min                       | Typ  | Max | Units    |
|-------------------------|--|--|---------------------------|------|-----|----------|
| t <sub>jphPCleG1</sub>  | Phase Jitter, PLL Mode<br>(Note 47)  | PCle Gen 1 (Notes 48, 49)  |                           | 13   | 86  | ps (p-p) |
| t <sub>jphPCleG2</sub>  |  | PCle Gen 2 Lo Band<br>10 kHz < f < 1.5 MHz (Note 48)                     |                           | 0.25 | 3.0 | ps (rms) |
|                         |  | PCle Gen 2 High Band<br>1.5 MHz < f < Nyquist (50 MHz) (Note 48)         |                           | 1.05 | 3.1 | ps (rms) |
| t <sub>jphPCleG3</sub>  |  | PCle Gen 3<br>(PLL BW of 2–4 MHz, CDR = 10 MHz)<br>(Notes 48, 50)        |                           | 0.21 | 1.0 | ps (rms) |
| t <sub>jphPCleG4</sub>  |  | PCle Gen 4<br>(PLL BW of 2–4 MHz, CDR = 10 MHz)<br>(Notes 48, 50)        |                           | 0.21 | 0.5 | ps (rms) |
| t <sub>jphUPI</sub>     |  | UPI<br>(9.6 Gb/s, 10.4 Gb/s or 11.2 Gb/s, 100 MHz, 12 UI)                |                           | 0.7  | 1.0 | ps (rms) |
| t <sub>jphQPI_SMI</sub> |  | QPI & SMI<br>(100 MHz or 133 MHz, 4.8 Gb/s, 6.4 Gb/s 12 UI)<br>(Note 51) |                           | 0.14 | 0.5 | ps (rms) |
|                         |  | QPI & SMI<br>(100 MHz, 8.0 Gb/s, 12 UI) (Note 51)                        |                           | 0.1  | 0.3 | ps (rms) |
|                         |  | QPI & SMI<br>(100 MHz, 9.6 Gb/s, 12 UI) (Note 51)                        |                           | 0.08 | 0.2 | ps (rms) |
| t <sub>jphPCleG1</sub>  |  | Additive Phase Jitter,<br>Bypass mode<br>(Note 47)                       | PCle Gen 1 (Notes 48, 49) |      |     | 10       |
| t <sub>jphPCleG2</sub>  | PCle Gen 2 Lo Band<br>10 kHz < f < 1.5 MHz (Notes 48, 52)                      |  |                           |      | 0.3 | ps (rms) |
|                         | PCle Gen 2 High Band 1.5 MHz < f < Nyquist<br>(50 MHz) (Notes 48, 52)          |  |                           |      | 0.6 | ps (rms) |
| t <sub>jphPCleG3</sub>  | PCle Gen 3<br>(PLL BW of 2–4 MHz, 2–5 MHz,<br>CDR = 10 MHz) (Notes 48, 50, 52) |  |                           |      | 0.2 | ps (rms) |
| t <sub>jphQPI_SMI</sub> | QPI & SMI<br>(100 MHz or 133 MHz, 4.8 Gb/s,<br>6.4 Gb/s 12 UI) (Notes 51, 52)  |  |                           |      | 0.2 | ps (rms) |
|                         | QPI & SMI<br>(100 MHz, 8.0 Gb/s, 12 UI) (Notes 51, 52)                         |  |                           |      | 0.1 | ps (rms) |
|                         | QPI & SMI<br>(100 MHz, 9.6 Gb/s, 12 UI) (Notes 51, 52)                         |  |                           |      | 0.1 | ps (rms) |

47. Applies to all outputs.

48. See <http://www.pcisig.com> for complete specs

49. Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1–12.

50. Subject to final ratification by PCI SIG.

51. Calculated from Intel-supplied Clock Jitter Tool v 1.6.3

52. For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)<sup>2</sup> = (total jitter)<sup>2</sup> - (input jitter)<sup>2</sup>

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**Table 16. CLOCK PERIODS – Differential Outputs with Spread Spectrum Disabled**

| SSC OFF                | Center Freq. MHz | Measurement Window      |                             |                             |                      |                             |                             |                         | Units |
|------------------------|------------------|-------------------------|-----------------------------|-----------------------------|----------------------|-----------------------------|-----------------------------|-------------------------|-------|
|                        |                  | 1 Clock                 | 1 $\mu$ s                   | 0.1 s                       | 0.1 s                | 0.1 s                       | 1 $\mu$ s                   | 1 Clock                 |       |
|                        |                  | -c2c Jitter Abs Per Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c Jitter Abs Per Max |       |
| DIF (Notes 53, 54, 55) | 100.00           | 9.94900                 |                             | 9.99900                     | 10.00000             | 10.00100                    |                             | 10.05100                | ns    |
| DIF (Notes 53, 54, 56) | 133.33           | 7.44925                 |                             | 7.49925                     | 7.50000              | 7.50075                     |                             | 7.55075                 | ns    |

**Table 17. CLOCK PERIODS – Differential Outputs with Spread Spectrum Enabled**

| SSC ON                 | Center Freq. MHz | Measurement Window      |                             |                             |                      |                             |                             |                         | Units |
|------------------------|------------------|-------------------------|-----------------------------|-----------------------------|----------------------|-----------------------------|-----------------------------|-------------------------|-------|
|                        |                  | 1 Clock                 | 1 $\mu$ s                   | 0.1 s                       | 0.1 s                | 0.1 s                       | 1 $\mu$ s                   | 1 Clock                 |       |
|                        |                  | -c2c Jitter Abs Per Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c Jitter Abs Per Max |       |
| DIF (Notes 53, 54, 55) | 99.75            | 9.94906                 | 9.99906                     | 10.02406                    | 10.02506             | 10.02607                    | 10.05107                    | 10.10107                | ns    |
| DIF (Notes 53, 54, 56) | 133.00           | 7.44930                 | 7.49930                     | 7.51805                     | 7.51880              | 7.51955                     | 7.53830                     | 7.58830                 | ns    |

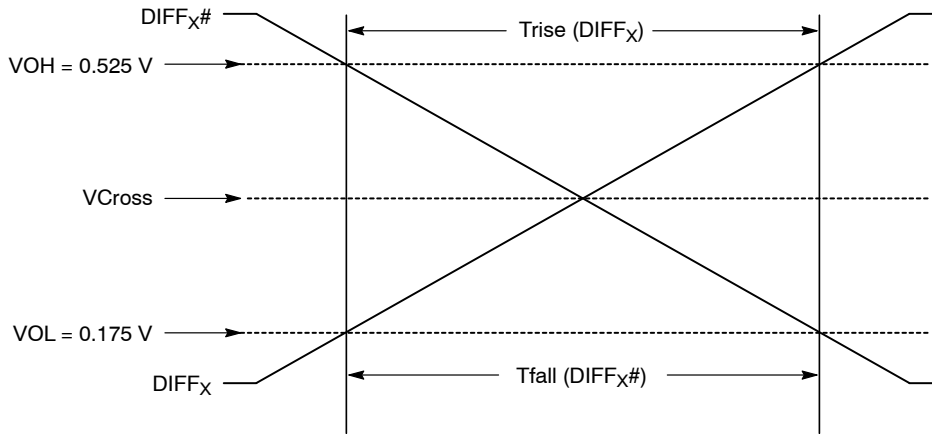
53. Guaranteed by design and characterization, not tested in production.

54. All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements ( $\pm 100$  ppm). The device itself does not contribute to ppm error.

55. Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

56. Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

## MEASUREMENT POINTS FOR DIFFERENTIAL



**Figure 3. Single-Ended Measurement Points for Trise, Tfall**

MEASUREMENT POINTS FOR DIFFERENTIAL

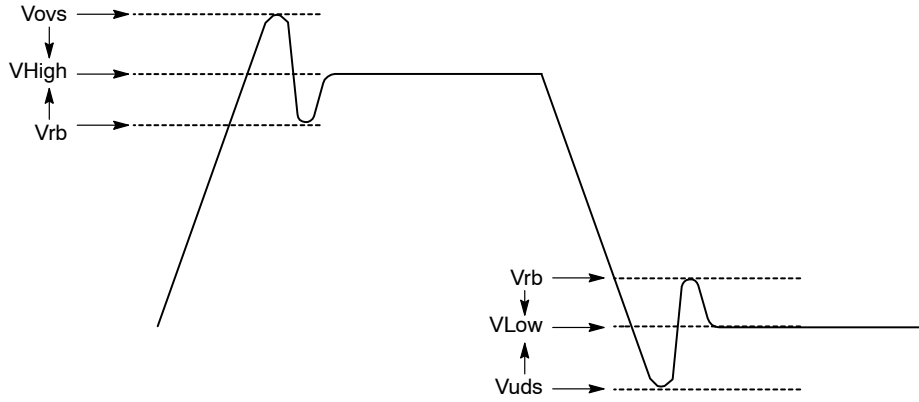


Figure 4. Single-Ended Measurement Points for Vovs, Vuds, Vrb

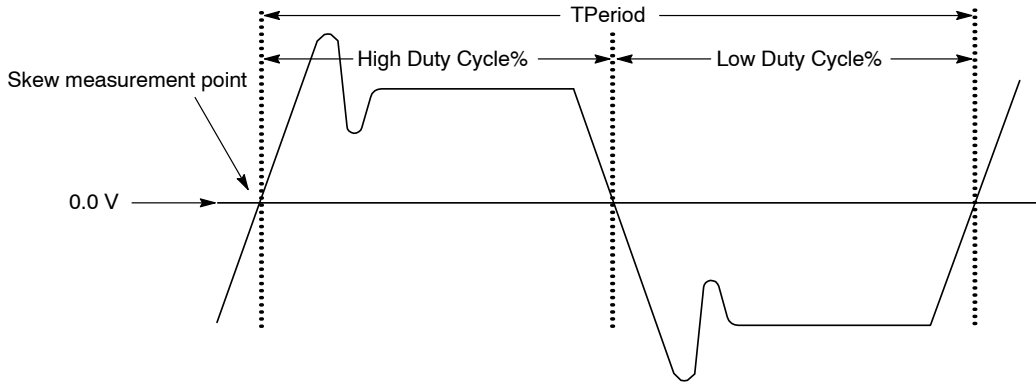


Figure 5. Differential (DIFF<sub>x</sub> – DIFF<sub>x</sub> #) Measurement Points (Tperiod, Duty Cycle, Jitter)

Test Loads

| Differential Output Terminations |        |
|----------------------------------|--------|
| DIF Zo (Ω)                       | Rs (Ω) |
| 100                              | 33     |
| 85                               | 27     |

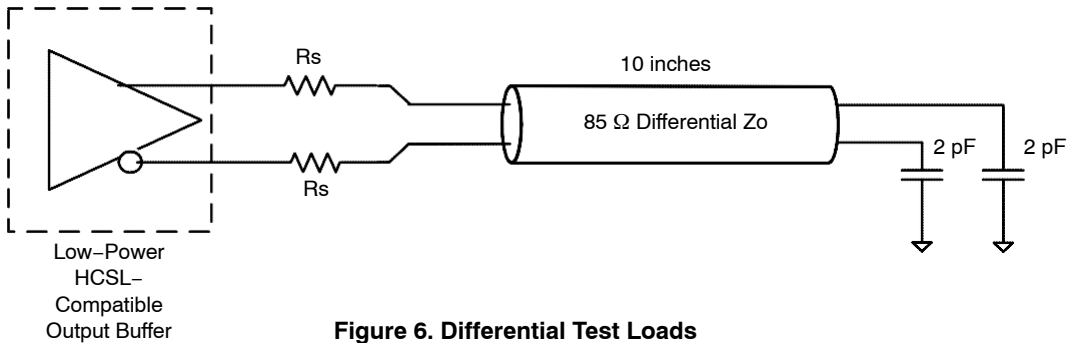


Figure 6. Differential Test Loads

SIGNAL AND FEATURE OPERATION

**CLK\_IN, CLK\_IN#**

The differential input clock is expected to be sourced from a clock synthesizer with an HCSL-compatible output, e.g. CK420BQ, CK-NET, CK-uS, or CK509B or another driver.

**OE# and Output Enables (Control Registers)**

Each output can be individually enabled or disabled by SMBus control register bits. Additionally, each output of the DIF[7:0] has a dedicated OE# pin. The OE# pins are asynchronous asserted-low signals. The Output Enable bits in the SMBus registers are active high and are set to enable by default.

The disabled state for the NB3W800L low power NMOS Push-Pull outputs is Low/Low.

Please note that the logic level for assertion or deassertion is different in software than it is on hardware. Output is enabled if OE# pin is pulled low and still maintains software programming logic with output enabled if OE register is true.

The assertion and de-assertion of this signal is absolutely asynchronous.

**OE# Assertion (Transition from '1' to '0')**

All differential outputs that were tristated will resume normal operation in a glitch free manner.

**OE# De-Assertion (Transition from '0' to '1')**

Corresponding output will transition from normal operation to tri-state in a glitch free manner.

**100M\_133M# – Frequency Selection**

The 100M\_133M# is a hardware pin, which programs the appropriate output frequency of the DIF pairs. Note that the CLK\_IN frequency is equal to CLK\_OUT frequency. An external pull-up or pull-down resistor is attached to this pin to select the input/output frequency.

**PWRGD/PWRDN#**

PWRGD/PWRDN# is a dual function pin. PWRGD is asserted high and de-asserted low. De-assertion of PWRGD (pulling the signal low) is equivalent to indicating a powerdown condition. PWRGD (assertion) is used by the NB3W800L to sample initial configurations such as frequency select condition and SA selections.

After PWRGD has been asserted high for the first time, the pin becomes a PWRDN# (Power Down) pin that can be used to shut off all clocks cleanly and instruct the device to invoke power savings mode. PWRDN# is a completely asynchronous active low input. When entering power savings mode, PWRDN# should be asserted low **prior to shutting off the input clock or power** to ensure all clocks shut down in a glitch free manner. When PWRDN# is asserted low by two consecutive rising edges of DIF#, all differential outputs are held tri-stated on the next DIF# high to low transition. The assertion and de-assertion of PWRDN# is absolutely asynchronous.

**WARNING:** Disabling of the CLK\_IN input clock prior to assertion of PWRDN# is an undefined mode and not recommended. Operation in this mode may result in glitches, excessive frequency shifting, etc.

Table 18. PWRGD/PWRDN# FUNCTIONALITY

| PWRGD/PWRDN# | DIF       | DIF#      |
|--------------|-----------|-----------|
| 0            | Tri-state | Tri-state |
| 1            | Running   | Running   |

**HBW\_BYPASS\_LBW#**

The HBW\_BYPASS\_LBW# is a tri level function input pin. It is used to select between PLL high bandwidth, bypass mode and PLL low bandwidth mode.

**POWER FILTERING EXAMPLE**

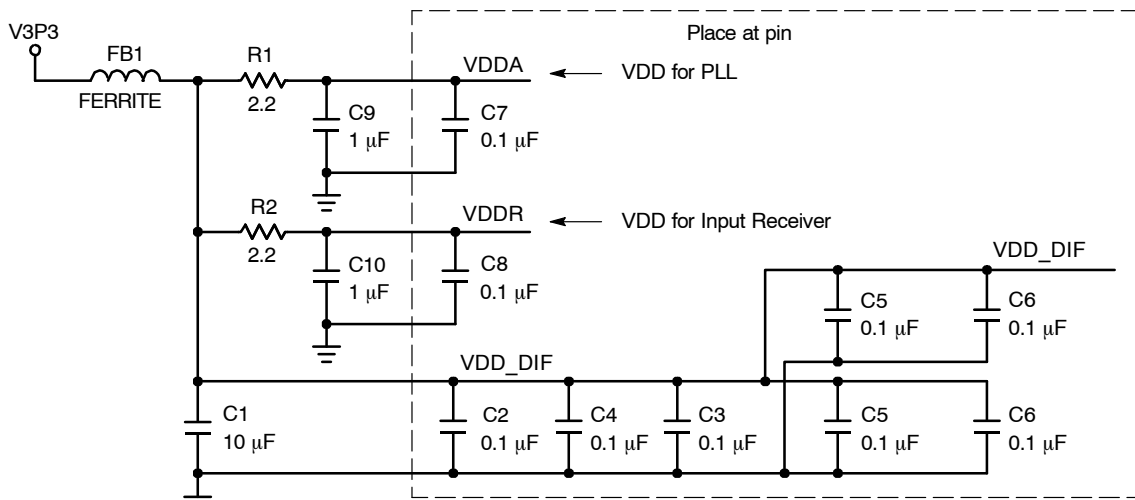


Figure 7. Schematic Example of the NB3W800L Power Filtering

Buffer Power-Up State Machine

Table 19. BUFFER POWER-UP STATE MACHINE

| State | Description  |
|-------|--|
| 0     | 3.3 V Buffer power off   |
| 1     | After 3.3 V supply is detected to rise above 3.135 V, the buffer enters State 1 and initiates a 0.1 ms–0.3 ms delay.                 |
| 2     | Buffer waits for a valid clock on the CLK input and PWRDN# de-assertion (or PWRGD assertion low to high)                             |
| 3     | Once the PLL is locked to the CLK_IN input clock, the buffer enters state 3 and enables outputs for normal operation. (Notes 57, 58) |

57. The total power up latency from power on to all outputs active must be less than 1.8 ms (assuming a valid clock is present on CLK\_IN input).  
 58. If power is valid and powerdown is de-asserted (PWRGD asserted) but no input clocks are present on the CLK\_IN input, DIF clocks must remain disabled. Only after valid input clocks are detected, valid power, PWRDN# de-asserted (PWRGD asserted) with the PLL locked/stable and the DIF outputs enabled.

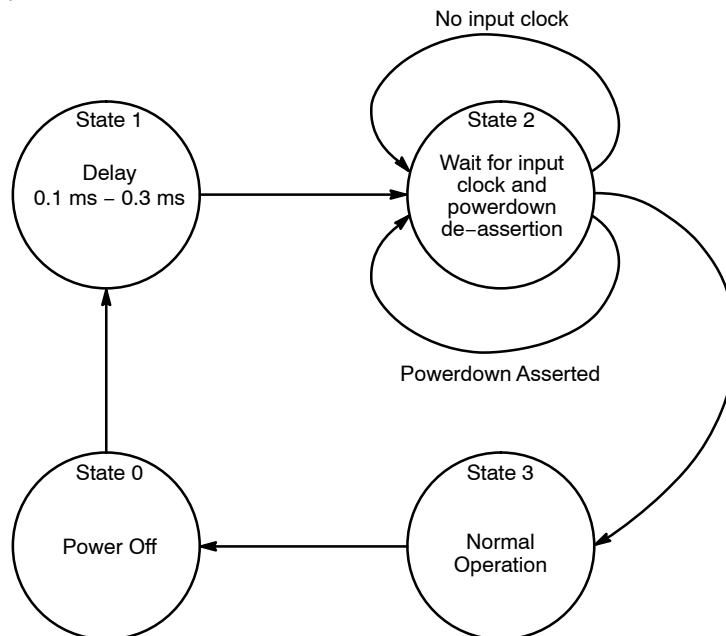


Figure 8. Buffer Power-Up State Diagram

Device Power-Up Sequence

Follow the power-up sequence below for proper device functionality:

1. PWRGD/PWRDN# pin must be Low.
2. Assign remaining control pins to their required state (100M\_133M#, HBW\_BYPASS\_LBW#, SDA, SCL)

3. Apply power to the device.
4. Once the VDD pin has reached a valid VDDmin level (3.3V -5%), the PWRGD/PWRDN# pin must be asserted High. See Figure 9.

Note: If no clock is present on the CLK\_IN/CLK\_IN# pins when device is powered up, there will be no clock on DIF/DIF# outputs.

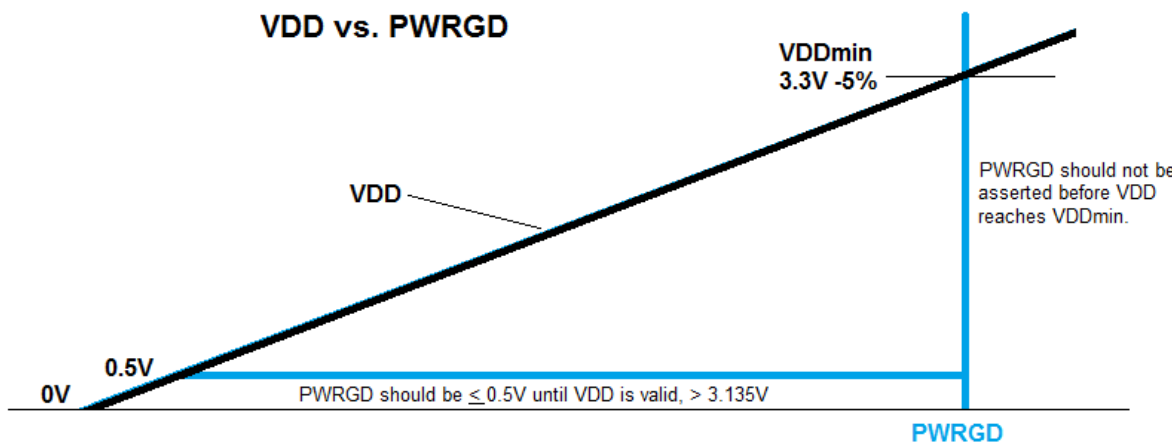


Figure 9. PWRGD and VDD Relationship Diagram

# NB3W800L

## GENERAL SMBUS SERIAL INTERFACE INFORMATION FOR NB3W800L

### How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- Clock(device) will **acknowledge**
- Controller (host) sends the beginning byte location = N
- Clock(device) will **acknowledge**
- Controller (host) sends the byte count = X
- Clock(device) will **acknowledge**
- Controller (host) starts sending Byte N through Byte N+X-1
- Clock(device) will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

| Index Block Write Operation |           |        |                |     |
|-----------------------------|-----------|--------|----------------|-----|
| Controller (Host)           |           | X Byte | Clock (Device) |     |
| T                           | starT bit |        |                |     |
| Slave Address               |           |        |                |     |
| WR                          | WRite     |        |                |     |
|                             |           |        |                | ACK |
| Beginning Byte = N          |           |        |                |     |
|                             |           |        |                | ACK |
| Data Byte Count = X         |           |        |                |     |
|                             |           |        |                | ACK |
| Beginning Byte N            |           |        |                |     |
|                             |           |        |                | ACK |
| O                           |           |        |                | O   |
| O                           |           |        |                | O   |
| O                           |           |        |                | O   |
|                             |           |        |                |     |
| Byte N + X - 1              |           |        |                |     |
|                             |           |        |                | ACK |
| P                           | stoP bit  |        |                |     |

### How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- Clock(device) will **acknowledge**
- Controller (host) sends the beginning byte location = N
- Clock(device) will **acknowledge**
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- Clock(device) will **acknowledge**
- Clock(device) will send the data byte count = X
- Clock(device) sends Byte N+X-1
- Clock(device) sends **Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| Index Block Read Operation |                 |        |                |                     |
|----------------------------|-----------------|--------|----------------|---------------------|
| Controller (Host)          |                 | X Byte | Clock (Device) |                     |
| T                          | starT bit       |        |                |                     |
| Slave Address              |                 |        |                |                     |
| WR                         | WRite           |        |                |                     |
|                            |                 |        |                | ACK                 |
| Beginning Byte = N         |                 |        |                |                     |
|                            |                 |        |                | ACK                 |
| RT                         | Repeat starT    |        |                |                     |
| Slave Address              |                 |        |                |                     |
| RD                         | ReaD            |        |                |                     |
|                            |                 |        |                | ACK                 |
|                            |                 |        |                |                     |
|                            |                 |        |                | Data Byte Count = X |
| ACK                        |                 |        |                |                     |
| ACK                        |                 |        |                | Beginning Byte N    |
| ACK                        |                 |        |                | O                   |
| O                          |                 |        |                | O                   |
| O                          |                 |        |                | O                   |
| O                          |                 |        |                |                     |
| ACK                        |                 |        |                | Byte N + X - 1      |
| N                          | Not acknowledge |        |                |                     |
| P                          | stoP bit        |        |                |                     |

# NB3W800L

**Table 20. SMBus TABLE: PLL MODE, AND FREQUENCY SELECT REGISTER**

| Byte 0 | Pin # | Name       | Control Function             | Type | 0                                     | 1             | Default             |
|--------|-------|------------|------------------------------|------|---------------------------------------|---------------|---------------------|
| Bit 7  | 48    | PLL Mode 1 | PLL Operating Mode Rd back 1 | R    | See PLL Operating Mode Readback Table |               | Latched at power up |
| Bit 6  | 48    | PLL Mode 0 | PLL Operating Mode Rd back 0 | R    |                                       |               | Latched at power up |
| Bit 5  |       | Reserved   |                              |      |                                       |               | 0                   |
| Bit 4  |       | Reserved   |                              |      |                                       |               | 0                   |
| Bit 3  |       | PLL_SW_EN  | Enable S/W control of PLL BW | RW   | HW Latch                              | SMBus Control | 0                   |
| Bit 2  |       | PLL Mode 1 | PLL Operating Mode 1         | RW   | See PLL Operating Mode Readback Table |               | 1                   |
| Bit 1  |       | PLL Mode 0 | PLL Operating Mode 0         | RW   |                                       |               | 1                   |
| Bit 0  | 47    | 100M_133M# | Frequency Select Readback    | R    | 133 MHz                               | 100 MHz       | Latched at power up |

NOTE: Setting bit 3 to '1' allows the user to override the Latch value from pin 48 via use of bits 2 and 1. Use the values from the PLL Operating Mode Readback Table. Note that Bits 7 and 6 will keep the value originally latched on pin 48. A warm reset of the system will have to be accomplished if the user changes these bits.

**Table 21. SMBus TABLE: OUTPUT CONTROL REGISTER**

| Byte 1 | Pin # | Name     | Control Function                       | Type | 0       | 1      | Default |
|--------|-------|----------|--|------|---------|--------|---------|
| Bit 7  | 32/33 | DIF_5_En | Output Control - '0' overrides OE# pin | RW   | Low/Low | Enable | 1       |
| Bit 6  | 28/29 | DIF_4_En | Output Control - '0' overrides OE# pin | RW   |         |        | 1       |
| Bit 5  | 25/26 | DIF_3_En | Output Control - '0' overrides OE# pin | RW   |         |        | 1       |
| Bit 4  | 21/22 | DIF_2_En | Output Control - '0' overrides OE# pin | RW   |         |        | 1       |
| Bit 3  |       | Reserved |  |      |         |        | 1       |
| Bit 2  | 16/17 | DIF_1_En | Output Control - '0' overrides OE# pin | RW   | Low/Low | Enable | 1       |
| Bit 1  | 13/14 | DIF_0_En | Output Control - '0' overrides OE# pin | RW   |         |        | 1       |
| Bit 0  |       | Reserved |  |      |         |        | 1       |

**Table 22. SMBus TABLE: OUTPUT CONTROL REGISTER**

| Byte 2 | Pin # | Name     | Control Function                       | Type | 0       | 1      | Default |
|--------|-------|----------|--|------|---------|--------|---------|
| Bit 7  |       | Reserved |  |      |         |        | 0       |
| Bit 6  |       | Reserved |  |      |         |        | 0       |
| Bit 5  |       | Reserved |  |      |         |        | 0       |
| Bit 4  |       | Reserved |  |      |         |        | 0       |
| Bit 3  |       | Reserved |  |      |         |        | 1       |
| Bit 2  | 39/40 | DIF_7_En | Output Control - '0' overrides OE# pin | RW   | Low/Low | Enable | 1       |
| Bit 1  |       | Reserved |  |      |         |        | 1       |
| Bit 0  | 35/36 | DIF_6_En | Output Control - '0' overrides OE# pin | RW   | Low/Low | Enable | 1       |

**Table 23. SMBus TABLE: RESERVED REGISTER**

| Byte 3 | Pin # | Name     | Control Function | Type | 0 | 1 | Default |
|--------|-------|----------|------------------|------|---|---|---------|
| Bit 7  |       | Reserved |                  |      |   |   | 0       |
| Bit 6  |       | Reserved |                  |      |   |   | 0       |
| Bit 5  |       | Reserved |                  |      |   |   | 0       |
| Bit 4  |       | Reserved |                  |      |   |   | 0       |
| Bit 3  |       | Reserved |                  |      |   |   | 0       |
| Bit 2  |       | Reserved |                  |      |   |   | 0       |
| Bit 1  |       | Reserved |                  |      |   |   | 0       |
| Bit 0  |       | Reserved |                  |      |   |   | 0       |

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**Table 24. SMBus TABLE: RESERVED REGISTER**

| Byte 4 | Pin # | Name | Control Function | Type | 0 | 1 | Default |
|--------|-------|------|------------------|------|---|---|---------|
| Bit 7  |       |      | Reserved         |      |   |   | 0       |
| Bit 6  |       |      | Reserved         |      |   |   | 0       |
| Bit 5  |       |      | Reserved         |      |   |   | 0       |
| Bit 4  |       |      | Reserved         |      |   |   | 0       |
| Bit 3  |       |      | Reserved         |      |   |   | 0       |
| Bit 2  |       |      | Reserved         |      |   |   | 0       |
| Bit 1  |       |      | Reserved         |      |   |   | 0       |
| Bit 0  |       |      | Reserved         |      |   |   | 0       |

**Table 25. SMBus TABLE: VENDOR & REVISION ID REGISTER**

| Byte 5 | Pin # | Name | Control Function | Type | 0            | 1 | Default |
|--------|-------|------|------------------|------|--------------|---|---------|
| Bit 7  | -     | RID3 | REVISION ID      | R    | A rev = 0000 |   | 0       |
| Bit 6  | -     | RID2 |                  | R    |              |   | 0       |
| Bit 5  | -     | RID1 |                  | R    |              |   | 0       |
| Bit 4  | -     | RID0 |                  | R    |              |   | 0       |
| Bit 3  | -     | VID3 | VENDOR ID        | R    | -            | - | 1       |
| Bit 2  | -     | VID2 |                  | R    | -            | - | 1       |
| Bit 1  | -     | VID1 |                  | R    | -            | - | 1       |
| Bit 0  | -     | VID0 |                  | R    | -            | - | 1       |

**Table 26. SMBus TABLE: DEVICE ID**

| Byte 6 | Pin # | Name | Control Function  | Type | 0 | 1 | Default |
|--------|-------|------|-------------------|------|---|---|---------|
| Bit 7  | -     |      | Device ID 7 (MSB) | R    |   |   | 1       |
| Bit 6  | -     |      | Device ID 6       | R    |   |   | 1       |
| Bit 5  | -     |      | Device ID 5       | R    |   |   | 1       |
| Bit 4  | -     |      | Device ID 4       | R    |   |   | 0       |
| Bit 3  | -     |      | Device ID 3       | R    |   |   | 0       |
| Bit 2  | -     |      | Device ID 2       | R    |   |   | 1       |
| Bit 1  | -     |      | Device ID 1       | R    |   |   | 1       |
| Bit 0  | -     |      | Device ID 0       | R    |   |   | 1       |

**Table 27. SMBus TABLE: BYTE COUNT REGISTER**

| Byte 7 | Pin # | Name | Control Function  | Type | 0   | 1 | Default |
|--------|-------|------|---|------|---|---|---------|
| Bit 7  |       |      | Reserved  |      |   |   | 0       |
| Bit 6  |       |      | Reserved  |      |   |   | 0       |
| Bit 5  |       |      | Reserved  |      |   |   | 0       |
| Bit 4  | -     | BC4  | Writing to this register configures how many bytes will be read back. | RW   | Default value is 8 hex, so 9 bytes (0 to 8) will be read back by default. |   | 0       |
| Bit 3  | -     | BC3  |   | RW   |   |   | 1       |
| Bit 2  | -     | BC2  |   | RW   |   |   | 0       |
| Bit 1  | -     | BC1  |   | RW   |   |   | 0       |
| Bit 0  | -     | BC0  |   | RW   |   |   | 0       |



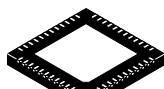
# NB3W800L

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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

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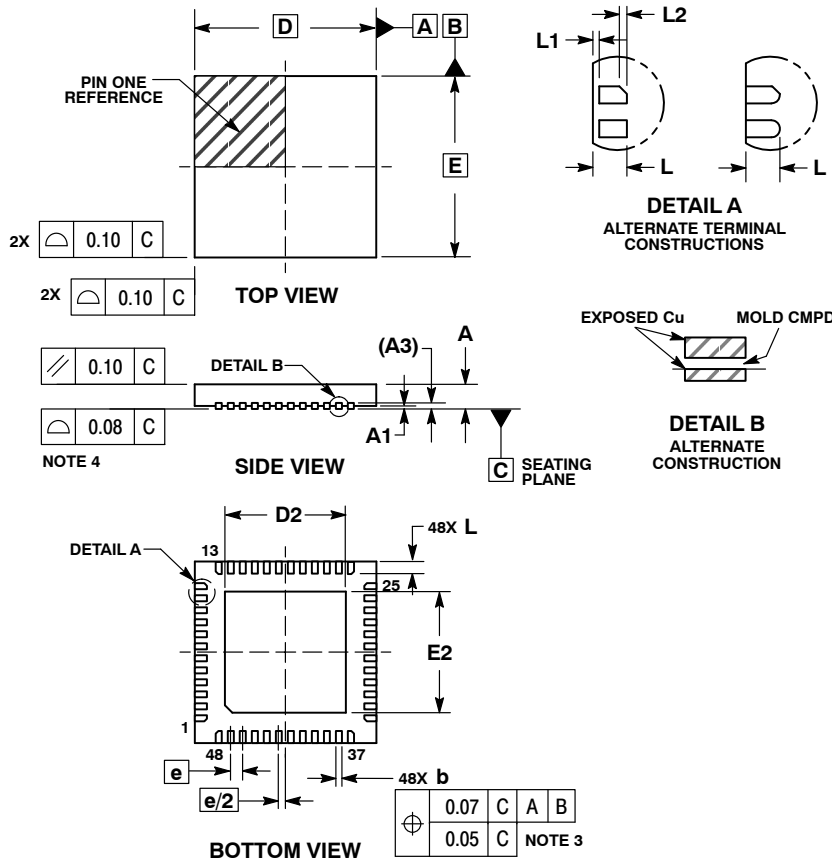


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SCALE 2:1

**QFN48 6x6, 0.4P**  
CASE 485DP  
ISSUE O

DATE 27 MAY 2014

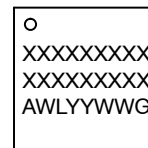


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.80 | 1.00 |
| A1          | 0.00 | 0.05 |
| A3          | 0.20 | REF  |
| b           | 0.15 | 0.25 |
| D           | 6.00 | BSC  |
| D2          | 3.90 | 4.10 |
| E           | 6.00 | BSC  |
| E2          | 3.90 | 4.10 |
| e           | 0.40 | BSC  |
| L           | 0.30 | 0.50 |
| L1          | 0.00 | 0.15 |
| L2          | 0.08 | REF  |

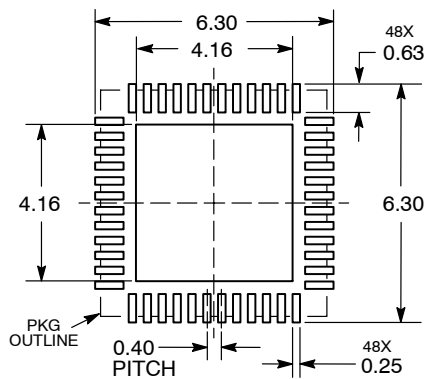
**GENERIC MARKING DIAGRAM\***



- XXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- YY = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

**SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

|                         |                        |  |
|-------------------------|------------------------|--|
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